TOSHIBA TPS625,TPS626

TOSHIBA PHOTO DARLINGTON TRANSISTOR SILICON NPN EPITAXIAL PLANAR

TPS625, TPS626

OPTO-ELECTRONIC SWITCH HOME ELECTRIC EQUIPMENT OA EQUIPMENT

Small side view epoxy resin package

High sensitivity : TPS625 \cdots I_L=0.6mA (MIN.)

 $TPS626 \cdots I_L = 0.4 \text{mA (MIN.)}$

: $\theta_{\frac{1}{2}} = \pm 15^{\circ} (TYP.)$ Half value angle

Visible light cut type (black package): TPS626

Optimum in combination with infrared LED TLN117 which has identical external dimensions.

CHARACTERISTIC	SYMBOL	RATING	UNIT
Collector-Emitter Voltage	v_{CEO}	30	V
Emitter-Collector Voltage	V_{ECO}	5	V
Collector Current	$I_{\mathbf{C}}$	40	mA
Collector Power Dissipation	PC	75	mW
Collector Power Dissipation Derating (Ta>25°C)	ΔP _C /°C	-1	mW/°C
Operating Temperature Range	Topr	-25~85	°C
Storage Temperature Range	$T_{ m stg}$	-40~100	°C
Soldering Temperature (5s)	T _{sol}	260 (Note 1)	°C

Note 1: Soldering portion of lead: above 2mm from the body of the device.

Unit in mm (): REFERENCE VALUE **JEDEC EIAJ TOSHIBA**

Weight: 0.1g (TYP.)

OPTO-ELECTRICAL CARACTERISTICS (Ta = 25°)

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CHARACTERI	STIC	SYMBOL	TEST CONDITION		MIN.	TYP.	MAX.	UNIT
Dark Current		$I_{D}(I_{CEO})$	$V_{CE} = 16V, E = 0$		_	0.03	0.25	μ A
Light Current		${ m I_L}$	$E = 0.1 \text{mW} / \text{cm}^2$ $V_{CE} = 3 \text{V (Note 2, 3)}$	TPS625	0.6	2	_	mA
				TPS626	0.4	1.4	_	
Collector-Emitter S Voltage	aturation	V _{CE} (sat)	$E = 0.1 \text{mW} / \text{cm}^2$ $I_L = (\text{Note 4})$		-	0.9	1.2	V
Peak Sensitivity Wavelength		$\lambda_{ m p}$		TPS625	_	820	_	nm
				TPS626	_	870	_	nm
Half Value Angle		$\theta_{\frac{1}{2}}$			_	±15	_	0
Switching Time	Rise Time	${ m t_r}$	$V_{CC}=5V, I_{C}=10mA$			200	_	,,,
	Fall Time	t_f	$ m V_{CC}$ =5V, I _C =10mA R _L =100 Ω		_	150	_	μ s

Color temperature = 2870°K, Standard Tungsten Lamp

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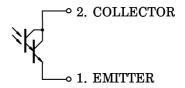
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Note 3. IL Classification

RANK	IL (mA)		
KANK	TPS625	TPS626	
(A)	0.6~3.6	0.4~2.4	
(B)	2.5~15	1.7~10.2	
(C)	5MIN.	3MIN.	
_	0.6MIN.	0.4MIN.	

Note 4. TPS625: 0.3mA, TPS626: 0.2mA

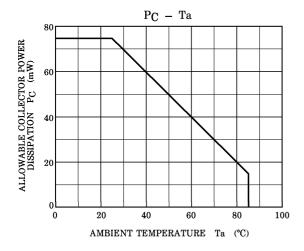
PIN CONNECTION

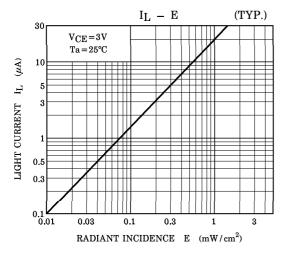


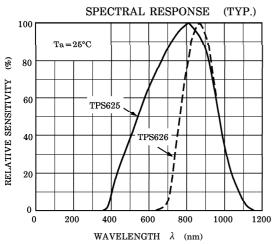
PRECAUTION

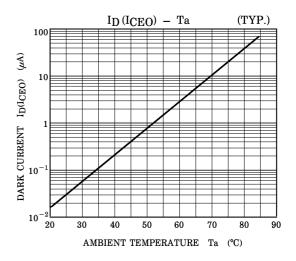
Please be careful of the followings.

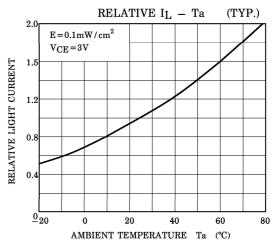
 When the lead is formed, the lead shall be formed at a distance of 2mm from the body without leaving forming stress to the body of the device.
 Soldering shall be performed after lead forming.



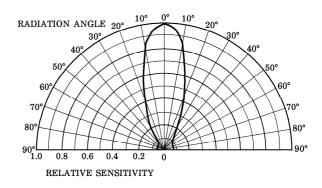












SWITCHING TIME TEST CIRCUIT

